

# SN74AS1821 10-BIT BUS INTERFACE FLIP-FLOPS WITH 3-STATE OUTPUTS

SDAS131 – APRIL 1987

- Center  $V_{CC}$  and GND Configuration Provides Minimum Lead Inductance in High Current Switching Applications
- Provides Extra Data Width Necessary for Wider Address/Data Paths or Buses with Parity
- Outputs Have Undershoot Protection Circuitry
- Power-Up High-Impedance State
- Package Options include Plastic DIPs. Use the 'AS821 for Plastic and Ceramic Chip Carriers and "Small Outline" Package Options.
- Buffered Control inputs to Reduce DC Loading Effects

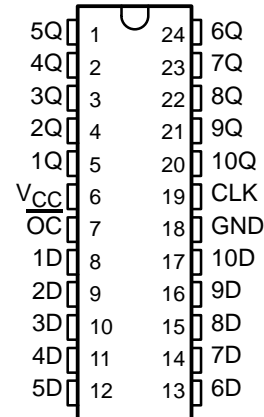
## description

This 10-bit flip-flop device features three-state outputs designed specifically for driving highly capacitive or relatively low-impedance loads. It is particularly suitable for implementing wider buffer registers, I/O ports, bidirectional bus drivers with parity, and working registers. The ten flip-flops are edge-triggered D-type flip-flops. On the positive transition of the clock, the Q outputs on the 'AS1821 will be true.

A buffered output-control input can be used to place the ten outputs in either a normal logic state (high or low levels) or a high-impedance state. In the high-impedance state the outputs neither load nor drive the bus lines significantly. The high-impedance state and increased drive provide the capability to drive the bus lines in a bus-organized system without need for interface or pull-up components. The output control ( $\overline{OC}$ ) does not affect the internal operation of the flipflops. Old data can be retained or new data can be entered while the outputs are in the high-impedance state.

The SN74AS1821 is characterized for operation from 0°C to 70°C.

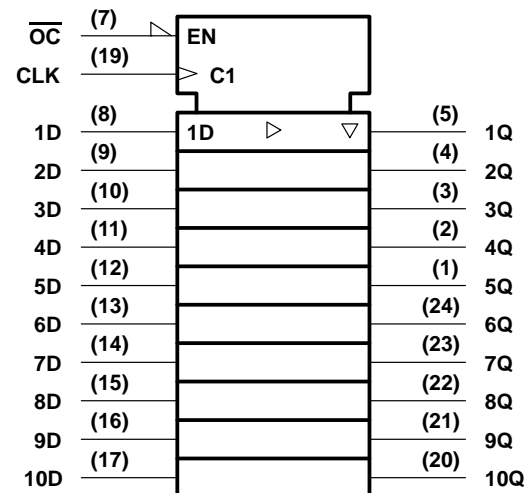
NT PACKAGE  
(TOP VIEW)



FUNCTION TABLE  
(each flip-flop)

INPUTS			OUTPUT
$\overline{OC}$	CLK	D	Q
L	↑	H	H
L	↑	L	L
L	L	X	$Q_0$
H	X	X	Z

## logic symbol†



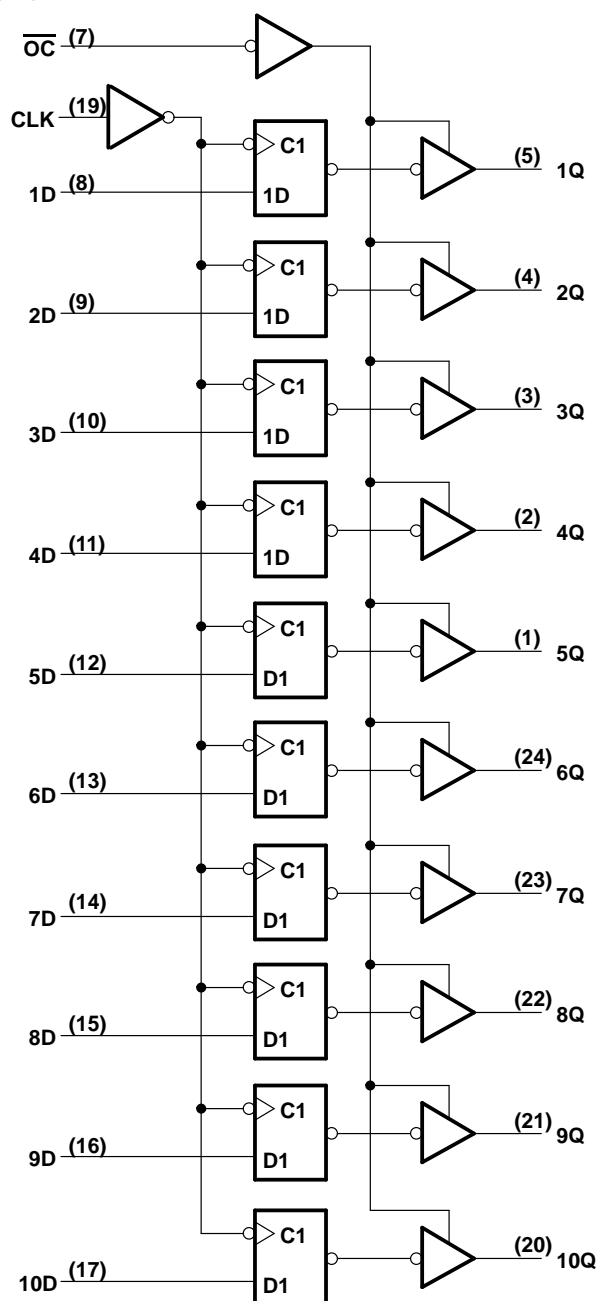
† This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

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logic diagram (positive logic)



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### absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, $V_{CC}$	7V
Input voltage	7 V
Voltage applied to a disabled 3-state output	5.5 V
Operating free-air temperature range	0°C to 70°C
Storage temperature range	–65°C to 150°C

### recommended operating conditions

	MIN	NOM	MAX	UNIT
$V_{CC}$ Supply Voltage	4.5	5	5.5	V
$V_{IH}$ High-level input voltage	2			V
$V_{IL}$ Low-level input voltage			0.8	V
$V_{OH}$ High-level output current			–24	mA
$I_{OL}$ Low-level output current			48	mA
$t_w$ Pulse duration, CLK high or low	8			ns
$t_{su}$ Setup time, data before CLK $\uparrow$	6			ns
$t_h$ Hold time, data after CLK $\uparrow$	0			ns
$T_A$ Operating free-air temperature	0		70	°C

### electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS		MIN	TYP†	MAX	UNIT
$V_{IK}$	$V_{CC} = 4.5$ V	$I_I = -18$ mA			–1.2	V
$V_{OH}$	$V_{CC} = 4.5$ V to 5.5 V,	$I_{OH} = -2$ mA	$V_{CC}-2$			V
	$V_{CC} = 4.5$ V,	$I_{OH} = -15$ mA	2.4	3.2		
	$V_{CC} = 4.5$ V,	$I_{OH} = -24$ mA	2			
$V_{OL}$	$V_{CC} = 4.5$ V,	$I_{OL} = 32$ mA				V
	$V_{CC} = 4.5$ V,	$I_{OL} = 48$ mA	0.35	0.5		
$I_{OZH}$	$V_{CC} = 5.5$ V,	$V_O = 2.7$ V			50	μA
$I_{OZL}$	$V_{CC} = 5.5$ V,	$V_O = 0.4$ V			–50	μA
$I_I$	$V_{CC} = 5.5$ V,	$V_I = 7$ V			0.1	mA
$I_{IH}$	$V_{CC} = 5.5$ V,	$V_I = 2.7$ V			20	μA
$I_L$	$V_{CC} = 5.5$ V,	$V_I = 0.4$ V			0.5	mA
$I_{O}^{\ddagger}$	$V_{CC} = 5.5$ V,	$V_O = 2.25$ V	–30		–112	mA
$I_{CC}$	$V_{CC} 5.5$ V	Outputs high		55	88	mA
		Outputs low		68	09	
		Outputs disabled		70	113	

† All typical values are at  $V_{CC} = 5$  V,  $T_A = 25^\circ\text{C}$ .

‡ The output conditions have been chosen to produce a current that closely approximates one half of the true short-circuit output current,  $I_{[OS]}$

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### switching characteristics (see Note 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	V <sub>CC</sub> = 4.5 V to 5.5 V, C <sub>L</sub> = 50 pF, R1 = 500 Ω, R2 = 500 Ω, T <sub>A</sub> = MIN to MAX		UNIT
			MIN	MAX	
t <sub>PLH</sub>	CLK	Any Q	3.5	7.5	ns
t <sub>PHL</sub>			3.5	10.5	
t <sub>PZH</sub>	$\overline{OC}$	Any Q	4	11	ns
t <sub>PZL</sub>			4	2	
t <sub>PHZ</sub>	$\overline{OC}$	Any Q	2	8	ns
t <sub>PLZ</sub>			2	8	

NOTE 1: Load circuit and voltage waveforms are shown in Section 1 of the *ALS/AS Logic Data Book, 1986*.

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